S8CG, S8CJ, S8CK, S8CM

Vishay General Semiconductor

Surface-Mount Glass Passivated Rectifier



www.vishay.com

SMC (DO-214AB)

Cathode O Anode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS						
I _{F(AV)}	8.0 A					
V _{RRM}	400 V, 600 V, 800 V, 1000 V					
I _{FSM}	260 A					
I _R	10 µA					
V_F at I_F = 8 A (T_A = 125 °C)	0.87 V					
T _J max.	150 °C					
Package	SMC (DO-214AB)					
Circuit configuration	Single					

FEATURES

- Low profile package
- · Ideal for automated placement
- Glass passivated pellet chip junction
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 gualified available - Automotive ordering code: base P/NHM3
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMC (DO-214AB)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	S8CG	S8CJ	S8CK	S8CM	UNIT
Device marking code		8G	8J	8K	8M	
Maximum repetitive peak reverse voltage	V _{RRM}	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	400	600	800	1000	V
Maximum average forward restified averant	I _{F(AV)} ⁽¹⁾		А			
Maximum average forward rectified current	I _{F(AV)} ⁽²⁾		А			
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	260				А
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +150				°C

Notes

⁽¹⁾ Mounted on aluminum PCB 30 mm x 30 mm with aluminum heatsink

⁽²⁾ Free air, mounted on recommended copper pad area

Revision: 12-May-2023



RoHS

COMPLIANT

HALOGEN FREE



Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	$I_{F} = 4.0 \text{ A}$	T _A = 25 °C	- V _F (1)	0.89	-	V	
	I _F = 8.0 A			0.96	0.985		
	I _F = 4.0 A	– T _A = 125 °C		0.78	-		
	I _F = 8.0 A			0.87	0.935		
Reverse current	Rated V _B	T _A = 25 °C	I _R ⁽²⁾	-	10	μA	
	naleu v _R	T _A = 125 °C		-	350		
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	4	-	μs	
Typical junction capacitance	4.0 V, 1 MHz		CJ	79	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width; 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	S8CG	S8CJ	S8CK	S8CM	UNIT
Typical thermal resistance	R _{0JA} ⁽¹⁾	75				°C/W
Typical thermal resistance	R _{θJM} ⁽²⁾	9.5				0/10

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz.pad area; thermal resistance $R_{\theta,JA}$ - junction to ambient

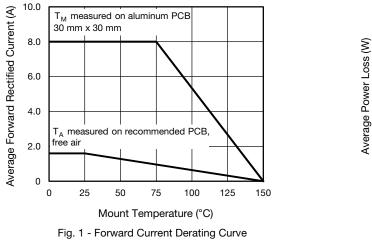
⁽²⁾ Mounted on 30 mm x 30 mm Aluminum PCB, thermal resistance R_{0JM} - junction to mount

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
S8CJ-M3/I	0.257	I	3500	13" diameter plastic tape and reel			
S8CJHM3/I ⁽¹⁾	0.257	l	3500	13" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)



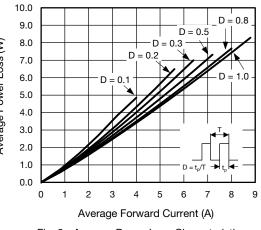


Fig. 2 - Average Power Loss Characteristics

Revision: 12-May-2023

2

Document Number: 87607



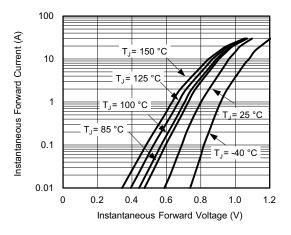
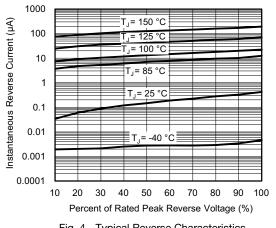
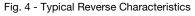
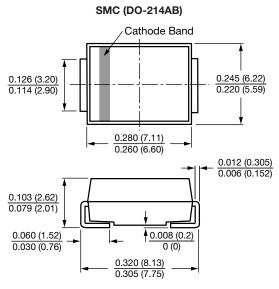


Fig. 3 - Typical Instantaneous Forward Characteristics









S8CG, S8CJ, S8CK, S8CM

Vishay General Semiconductor

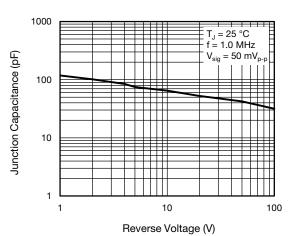


Fig. 5 - Typical Junction Capacitance

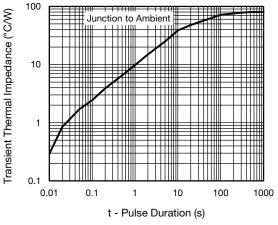
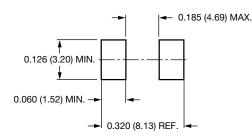


Fig. 6 - Typical Transient Thermal Impedance

Mounting Pad Layout



 Revision: 12-May-2023
 3
 Document Number: 87607

 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
 THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.